



# MULTILAYER CERAMIC BAND PASS FILTER

# **RBBPF Series – 2012(0805)- RoHS Compliance**

# Halogens Free Product

# 2.4 GHz ISM Band Working Frequency

# P/N: RBBPF2012050AHT

\*Contents in this sheet are subject to change without prior notice.

#### **Approval sheet**



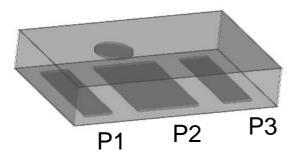
## FEATURES

- 1. Miniature footprint: 2.0 X 1.2X 0.5 mm<sup>3</sup>
- 2. Low Profile Thickness
- 3. High Rejection and Low Insertion Loss
- 4. High attenuation on 2110~ 2170MHz & 2<sup>nd</sup> harmonic suppressed
- 5. LTCC process

# APPLICATIONS

- 1. 2.4GHz RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g/n, HomeRF

## CONSTRUCTION



PIN	Connection			
1	Input port			
2	GND			
3 Output port				

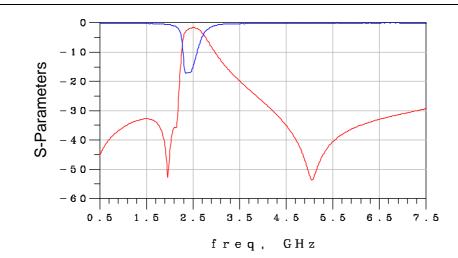
### DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	2.00 ± 0.15
	w	1.25 ± 0.10
	т	0.55 max.
	A	0.95 ± 0.10
	В	0.275 ± 0.10
	С	0.25 ± 0.10
	D	0.60 ± 0.10
т	E	0.175 ± 0.10
L	F	0.15 ± 0.10

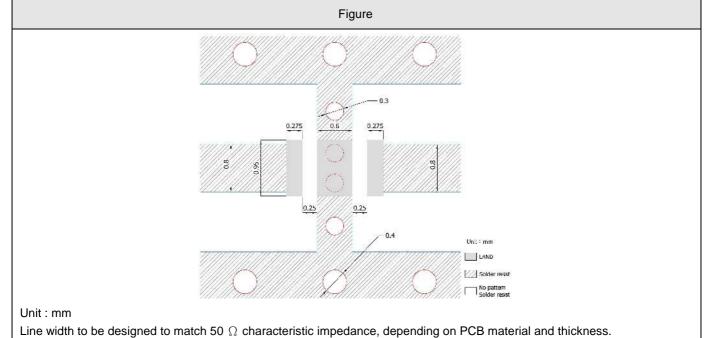


## **ELECTRICAL CHARACTERISTICS**

RBBPF2012050AHT	Specification
Frequency range	2450± 50 MHz
Insertion Loss	2.5 dB max (typ. 2.2 dB)
VSWR	2.0 max
Impedance	<b>50</b> Ω
Attenuation (min.)	25@ 746~ 764MHz 30@ 824~ 849MHz 26@ 869~ 960MHz 28@ 1570~ 1580MHz 28@ 1710~ 1785MHz 30@ 1850~ 1910MHz 30@ 1930~ 1990MHz 25@ 2110~ 2170MHz 15@ 3300~ 3800MHz 20@ 4800~ 5000MHz
Operation Temperature Range	-40°C ~ +85°C
Typical Electrical Chart	



# SOLDER LAND PATTERN



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### **RELIABILITY TEST**

Test item	Test condition / Test method	Specification		
Solderability JIS C 0050-4.6	*Solder bath temperature : $235 \pm 5^{\circ}$ C	At least 95% of a surface of each terminal		
JESD22-B102D	*Immersion time : $2 \pm 0.5$ sec	electrode must be covered by fresh solder.		
	Solder : Sn3Ag0.5Cu for lead-free			
Leaching (Resistance to dissolution	*Solder bath temperature : $260 \pm 5^{\circ}C$	Loss of metallization on the edges of each		
of metallization)	*Leaching immersion time : $30 \pm 0.5$ sec	electrode shall not exceed 25%.		
IEC 60068-2-58	Solder : SN63A			
Resistance to soldering heat	*Preheating temperature : 120~150℃,			
JIS C 0050-5.4	1 minute.	No mechanical damage.		
		Samples shall satisfy electrical specification after test.		
	*Solder temperature : 270±5°C	Loss of metallization on the edges of each		
	*Immersion time : 10±1 sec	electrode shall not exceed 25%.		
	Solder : Sn3Ag0.5Cu for lead-free			
	Measurement to be made after keeping at			
	room temperature for 24±2 hrs			
Drop Test	*Height:75 cm	No mechanical damage.		
JIS C 0044 Customer's specification.	*Test Surface : Rigid surface of concrete	Samples shall satisfy electrical specification		
	or steel.	after test.		
	*Times : 6 surfaces for each units ; 2			
Adhesive Strength	times for each side. *Pressurizing force :	No remarkable damage or removal of the		
of Termination	5N(≦0603) ; 10N(>0603)	termination.		
JIS C 0051- 7.4.3	*Test time : 10±1 sec			
Bending test	The middle part of substrate shall be	No mechanical damage.		
JIS C 0051- 7.4.1	pressurized by means of the pressurizing	Samples shall satisfy electrical specification		
	rod at a rate of about 1 mm/s per second	after test.		
	until the deflection becomes 1mm/s and			
	then pressure shall be maintained for $5\pm1$			
	sec.			
	Measurement to be made after keeping at			
	room temperature for 24±2 hours			

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Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical
	3. 30±3 minutes at +85°C±3°C,	specification after test.
	4. 10~15 minutes at room temperature,	
	Total 100 continuous cycles	
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
Vibration	*Frequency : 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude : 1.5mm	Samples shall satisfy electrical specification
	*Test times : 6hrs.(Two hrs each in three	after test.
	mutually perpendicular directions)	
High temperature JIS C 0021	*Temperature : 85°C±2°C	No mechanical damage.
	*Test duration : 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
Humidity	*Humidity : 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature:40±2°C	Samples shall satisfy electrical specification
JIS C 0022	*Time : 1000+24/-0 hrs.	after test.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
	% 500hrs measuring the first data then	
-	1000hrs data	
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.
JIS C 0020	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
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### SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

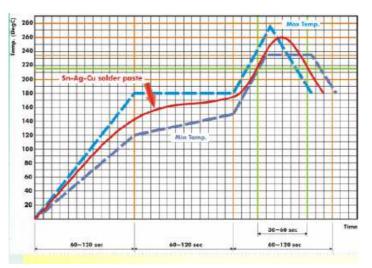
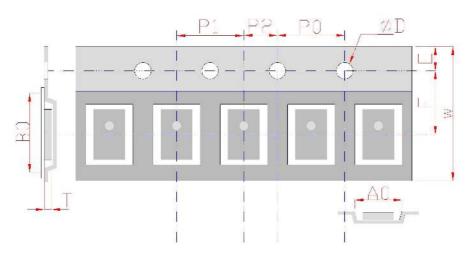


Fig 2. Infrared soldering profile

### **ORDERING CODE**

RB	BPF	201205	0	Α	Н	Т
Walsin	Product Code	Dimension code	Unit of	Application	Specification	Packing
RB:	BPF :	Per 2 digits of	dimension	A : 2.4GHZ ISM	Design code	T : Reeled
RF device	Band Pass Filter	Length, Width,	0 :0.1 mm	Band		
with DC		Thickness :	1 :1.0 mm			
block		e.g. :				
		201205 =				
		Length 20,				
		Width 12,				
		Thickness 05				

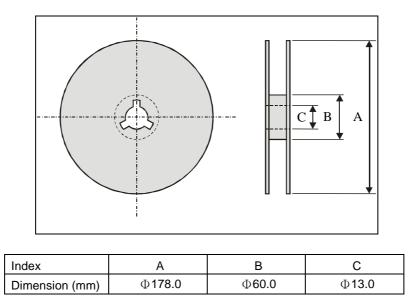
Minimum Ordering Quantity: 2000 pcs per reel. PACKAGING



### Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	$1.32\pm0.10$	$\textbf{2.25}\pm\textbf{0.10}$	1.50 + 0.10	$0.80\pm0.10$	$8.0\pm0.10$
Index	E	F	Po	P1	P2
Dimension (mm)	$1.75\pm0.10$	$3.50\pm0.05$	$4.00\pm0.10$	$4.00\pm0.10$	$2.00\pm0.10$

#### **Reel dimensions**



Taping Quantity: 2000 pieces per 7" reel

#### CAUTION OF HANDLING

#### Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

#### Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.
  - Temperature : -10 to +40°C
  - Humidity : 30 to 70% relative humidity
  - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
  - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
  - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
  - Products should be storage under the airtight packaged condition.